

FEATURES

ESD protection for high speed data lines to IEC61000-4-2

ESD contact discharge typical 8KV, max 15KV

| ESD air discharge typical 15KV, max 25KV

Surface mount

| Extremely low capacitance

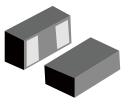
| Very low leakage current

Fast response time

| Bi-directional ESD protection

Lead free solder termination

The best ESD protection for high frequency, low voltage applications



0402



Schematic Symbol

APPLICATIONS

High Definition	Multi-Media I	Intertace (HL)MI)

Digital Visual Interface (DVI)

| Display Port Interface (DP)

| Unified Display Interface (UDI)

| Mobile Display Digital Interface (MDDI)

Gigabit Ethernet

USB2.0 and USB3.0

IEEE1394 interface

APPROVALS

RoHS	Compliance with 2011/65/EU
HF	Compliance with IEC61249-2-21:2003

CAUTION

This component is designed for signal line protection only, Not intended to be used under bias, not for application with a power line.



ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter Value		Unit
-	Maximum Contact discharge voltage Per IEC61000-4-2		V
-	Maximum Air discharge voltage Per IEC61000-4-2 25KV		V
T _{OPER}	Maximum Operating temperature -40 to +90		°C
T _{stg}	T_{STG} Maximum Storage temperature -55 to +125		°C
T _L Maximum lead temperature for soldering during 10s 260		°C	

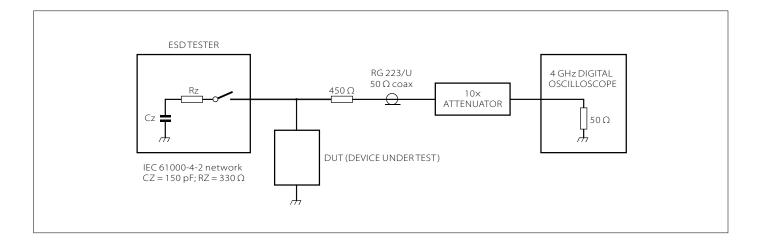
ELECTRICAL CHARACTERISTICS($T_A = 25$ °C)

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Unit
V_R	Rated Voltage	-	-	-	12	V
V _T	Trigger Voltage	IEC 61000-4-2 8KV contact discharge	-	300	-	V
V _C	Clamping Voltage	IEC 61000-4-28KV contact discharge	-	35	-	V
IL	Leakage Current	DC 5V shall be applied on component	-	0.01	0.10	μΑ
C _P	Capacitance	$V_R = 0V, f = 1 MHz$	-	0.05	-	рF

Note:

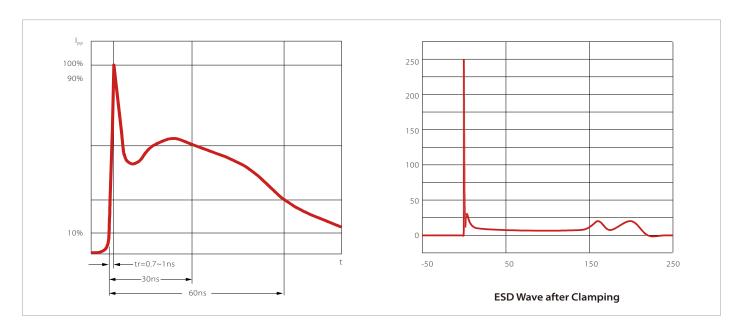
- $1.\ \ Trigger and clamping\ voltage\ are\ measured\ per\ IEC\ 61000-4-2,8KV\ contact\ discharge\ method.$
- $2 \quad \text{After reliability tests such as high temp storage, temp cycles, continuous ESD strike etc, the maximum leakage current is less than 10uA.} \\$

ESD CLAMPING TEST



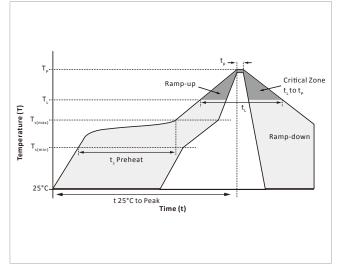


CHARACTERISTIC CURVES



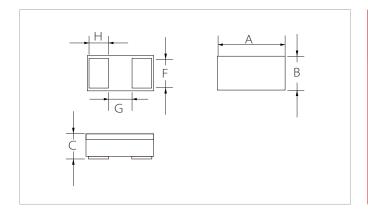
SOLDERING PARAMETERS

	Lead-free assembly	
	Temperature Max (T _{s(min)})	150°C
Pre Heat	Temperature Max (T _{s(max)})	200°C
	Time (min to max) (t_s)	60 – 180 secs
Average rai	Average ramp up rate (Liquidus Temp (T _L) to peak	
	T _{S(max)} to T _L - Ramp-up Rate	
Reflow	Temperature (T _L) (Liquidus)	217°C
Nellow	Time (min to max) (t _L)	60 – 150 seconds
PeakTempe	Peak Temperature (T _p)	
Time withir	Time within 5°C of actual peak Temperature (t _p)	
Ramp-dow	n Rate	6°C/second max
Time 25°C t	Time 25°C to peak Temperature (T _p)	
Do not exceed		260°C



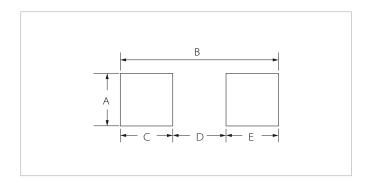


PACKAGE INFORMATION



Ref.	Dimension				
nei.	Min.	Тур.	Max.	Unit	
А	0.95	1.0	1.05		
В	0.45	0.50	0.55		
С	0.32	0.36	0.40	mm	
Н	0.28	0.30	0.32		
F	0.41	0.43	0.45		
G	0.32	0.34	0.36		

RECOMMENDED PAD LAYOUT DIMENSIONS



Ref.	Dimension	Unit
А	0.55	
В	1.05	
С	0.40	mm
D	0.25	
Е	0.40	

ORDERING INFORMATION

Part Number	Component Package	QTY/Reel	Reel Size
SAE0402B12UA	0402	10000PCS	7"



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